Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE: NEW ASSIGNMENT

NATURE OF CONVEYANCE: SECURITY AGREEMENT

CONVEYING PARTY DATA

Name	Execution Date
Ember Corporation	12/30/2009

RECEIVING PARTY DATA

Name:	WF Fund III Limited Partnership
Street Address:	161 Bay Street, Suite 2520
Internal Address:	c/o Willington Financial Fund III
City:	Toronto, Ontario
State/Country:	CANADA
Postal Code:	M5J 2S1

PROPERTY NUMBERS Total: 4

Property Type	Number
Application Number:	11610943
Application Number:	11303751
Application Number:	11063261
PCT Number:	US0505552

CORRESPONDENCE DATA

Fax Number: (617)502-5162

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: 6172485000

Email: kschoff@choate.com Correspondent Name: Choate Hall & Stewart LLP Two International Place Address Line 1: Address Line 2: Attn: Kell L. Schoff

Address Line 4: Boston, MASSACHUSETTS 02110

ATTORNEY DOCKET NUMBER: 2009260-0002

NAME OF SUBMITTER: Kell L. Schoff **PATENT**

REEL: 023831 FRAME: 0013 501072776

Total Attachments: 5

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PATENT SECURITY AGREEMENT

This PATENT SECURITY AGREEMENT (this "<u>Agreement</u>") is made as of December 30, 2009, by and among EMBER CORPORATION., a corporation duly organized and validly existing under the laws of the State of Delaware (the "<u>Grantor</u>") and WF FUND III LIMITED PARTNERSHIP, carrying on business as WELLINGTON FINANCIAL LP and WELLINGTON FINANCIAL FUND III (the "<u>Secured Party</u>").

Introduction

Pursuant to the Loan and Security Agreement dated as of the date hereof (as amended, restated, supplemented and/or modified from time to time, the "Loan and Security Agreement") by and between the Grantor and the Secured Party, the Secured Party has agreed, subject to the terms and conditions set forth therein, to make certain term and revolving credit loans and provide other financial accommodations to the Grantor (collectively, the "Loans"). Under the Loan and Security Agreement, the Grantor is required to execute and deliver this Agreement and to grant to the Secured Party a continuing security interest in all of the Patent Collateral (as defined below) to secure all of the Secured Obligations under, and as defined in, the Loan and Security Agreement.

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, and in order to induce the Secured Party to enter into the Loan and Security Agreement and make Loans to the Grantor pursuant thereto, Grantor agrees, for the benefit of the Secured Party, as follows:

SECTION 1. <u>Defined Terms</u>. Unless otherwise defined herein, terms defined in the Security Agreement and used herein have the meaning given to them in the Security Agreement.

SECTION 2. <u>Grant of Security Interest in Patent Collateral</u>. The Pledgor hereby pledges and grants to the Secured Party a lien on and a security interest in and to all of its right, title and interest in, to and under all of the following (the "<u>Patent Collateral</u>"):

- (a) Patents for which registrations or applications for registration are listed on Schedule I attached hereto;
 - (b) Goodwill associated with such Patents; and
 - (c) Proceeds of any and all of the foregoing.

SECTION 3. Security Agreement. The security interest granted pursuant to this Agreement is granted in conjunction with the security interest granted to the Secured Party pursuant to the Loan and Security Agreement and the Pledgor hereby acknowledge and affirm that the rights and remedies of the Secured Party with respect to the security interest in the Patents made and granted hereby are more fully set forth in the Loan and Security Agreement, the terms and provisions of which are incorporated by reference herein as if fully set forth herein. In the event that any provision of this Agreement is deemed to conflict with the Loan and Security Agreement, the provisions of the Loan and Security Agreement shall control.

Ember Patent Security Agreement 4586510

SECTION 4. <u>Termination</u>. When all of the Secured Obligations (other than contingent indemnification obligations not yet asserted, due or payable) have been paid and finally satisfied in full in cash and the Loan and Security Agreement shall have terminated, the Secured Party shall execute, acknowledge, and deliver to the Pledgor an instrument in writing in recordable form releasing the security interest in the Patents under the Loan and Security Agreement and this Agreement.

[Signature page follows.]

IN WITNESS WHEREOF, the Pledgor has caused this Agreement to be executed and delivered by its duly authorized officer as of the date first set forth above.

Very truly yours,

EMBER CORPORATION

By: Jamest Shukan Name: JAMES H. SHEEHAN Title: SUP & CFO

[Signature Page to Patent Security Agreement]

SCHEDULE I

Ember Patent Summary

11/30/2009

RECORDED: 01/22/2010

Reference	Alei.	1	Ł	ŀ			
Number		Country	App. No./ Senai No.	rilling Date	Апотеу	Status	Соттепіс
ISSUED							
018001	Clock Skew Compensation	Sn	11/610,943	12/14/2006	Œ	Notice of Issuance 1/20/09 Issue chare 2/3/09 US Pat 7,486,130	
PENDING-APPLICATIONS	PLICATIONS						
014001 752P004	Preamble Detection	sn	11/303,751	12/14/2005	NF	Notice of Issuance 1/22/09 Issue date 2/10/09 US Pat 7,489,906 Sisuance posiponed-Reopening Prosecution Office Action 6/10/09 Telephonic Interviews 98/09 and 9/9/09	Awaiting office response/notice of issuance
011001 752P002	Monitoring Network Traffic	Sn	11/063,261	2/22/2005	N F	Prelim Amendment and Information Disclosure filed 8/8/06 Information and Disclosure Start filed 8/1/06 First Orlice Action 9/9/08 response 4/6/09 Office Action 9/18/09 Amended 11/17/09 to cancel claims with request for issuance on allowed claims	Awaiing office response/notice of issuance Cancelled claims to be renewed
002JP1	Ad Hoc Wireless Network Using Gradient Routing	Japan	2004-512301	6/9/2003	Æ	Application Published 9/26/05	US app abandoned
002HK1	Ad Hoc Wireless Network Using Gradient Routing	Hong Kang	Kong 3757416.7	9/15/2006	Œ	Validated Euro filing in Hong Kong 10/26/05	US app abandoned
002KR1	Ad Hoc Wireless Network Using Gradient Routing	S. Korea	S. Korea 10-2004-7019924	6/9/2003	Œ	Application published	US app abandoned
008WO1	Routing in an Asymmetrical Link Wirelss Network	PCT/WIPO	PCT/WIPO PCT/US2005/005552	2/22/2005	Œ	National Phase	US app abandoned